## SURFACE MOUNT SILICON LOW V<sub>F</sub> SCHOTTKY DIODE



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# **DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMDSH05-4 is a 40 Volt Schottky diode packaged in a space saving surface mount SOD-323 case. This device has been designed for applications requiring a low forward voltage drop.

**MARKING CODE: C55** 



### SOD-323 CASE

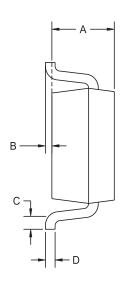
MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	$V_{RRM}$	40	V
Continuous Forward Current	I <sub>F</sub>	500	mA
Peak Repetitive Forward Current, tp≤1.0ms	I <sub>FRM</sub>	3.5	Α
Peak Forward Surge Current, tp=8.0ms	I <sub>FSM</sub>	10	Α
Power Dissipation	$P_{D}$	250	mW
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Thermal Resistance	$\Theta_{JA}$	500	°C/W

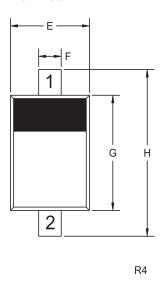
ELECTRICAL	. CHARACTERISTICS: (1 <sub>A</sub> =25°C unle	ess otherwise	noted)		
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
$I_R$	V <sub>R</sub> =10V			30	μΑ
$I_{R}$	V <sub>R</sub> =30V		60	100	μΑ
$I_R$	V <sub>R</sub> =30V, T <sub>A</sub> =85°C		2.5		mA
$I_{R}$	V <sub>R</sub> =30V, T <sub>A</sub> =100°C		6.0		mA
$BV_R$	I <sub>R</sub> =500μA	40			V
$V_{F}$	I <sub>F</sub> =100μA			0.13	V
VF	I <sub>F</sub> =1.0mA			0.21	V
VF	I <sub>F</sub> =10mA			0.27	V
$V_{F}$	I <sub>F</sub> =100mA			0.35	V
VF	I <sub>F</sub> =500mA			0.47	V
CJ	V <sub>R</sub> =1.0V, f=1.0MHz			50	pF

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### **SOD-323 CASE - MECHANICAL OUTLINE**





# LEAD CODE:

- 1) Cathode
- 2) Anode

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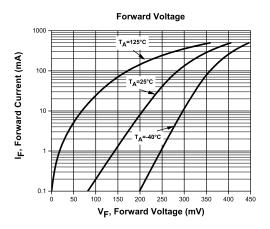
DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.031	0.039	0.80	1.00			
В	0.000	0.004	0.00	0.10			
С	0.008	-	0.20	-			
D	0.004	0.007	0.11	0.19			
E	0.045	0.053	1.15	1.35			
F	-	0.014	-	0.35			
G	0.063	0.071	1.60	1.80			
Н	0.094	0.102	2.40	2.60			

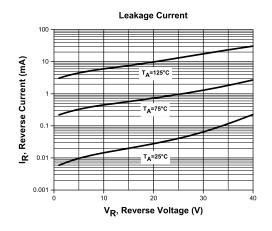
SOD-323 (REV: R4)

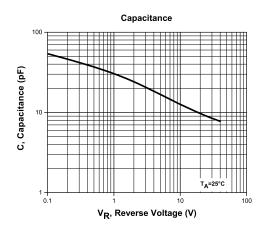
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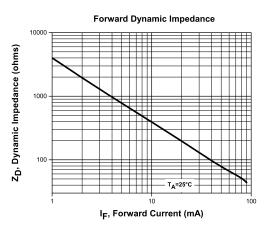


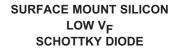
## TYPICAL ELECTRICAL CHARACTERISTICS





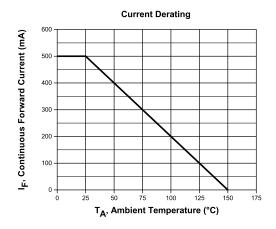


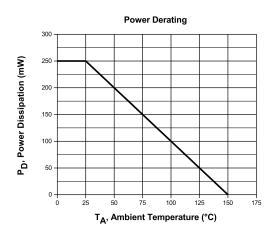






## TYPICAL ELECTRICAL CHARACTERISTICS





### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- · Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

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